

Data sheet Product ICK LED R 28 x 15 G



Heatsinks and active heatsinks for processors>Heatsinks for LEDs
 Ø 28 x 15 mm, for IC design LED

Features

diameter:	27.95 mm
way of fixation:	<ul style="list-style-type: none"> • therm. conductive foil • therm. cond. adhesive
height:	15.24 mm
plate thickness:	3.5 mm
thermal resistance:	15.72 - 3.8 K/W
dissipation loss:	7.6 W
surface:	black anodised

Technical Drawing

